

Title (en)
CONDUCTIVE PREPARATION AND METHOD FOR THE PRODUCTION THEREOF

Title (de)
LEITFÄHIGE ZUBEREITUNG SOWIE VERFAHREN ZU DEREN HERSTELLUNG

Title (fr)
PRÉPARATION CONDUCTRICE ET PROCÉDÉ DE FABRICATION

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Abstract (en)
[origin: WO2010066730A1] The invention relates to a conductive preparation, in particular an electrically and/or thermally conductive preparation, characterised by a first, at least temporarily liquid phase and at least one, preferably at least two conductive additives provided in said first phase. A method for producing a conductive preparation of this type is characterised by the following steps: A) provision of a first at least temporarily liquid phase; B) addition of at least one conductive additive, preferably at least two conductive additives to the first phase; C) mixing of the first phase and the conductive additive(s) into a homogeneous state.

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